

AMENDMENT TRANSMITTAL LETTER (Large Entity)

Applicant(s): Seung-Pil Chung et al.

MAY 27 2004

Docket No.

SEC.760

Serial No.
09/689,814Filing Date
13 October 2000Examiner
L. Alejandro MuleroGroup Art Unit
1763

Invention: **METHOD FOR REMOVING OXIDE LAYER AND SEMICONDUCTOR MANUFACTURING APPARATUS FOR REMOVING OXIDE LAYER**

TO THE COMMISSIONER FOR PATENTS:

Transmitted herewith is an amendment in the above-identified application.

The fee has been calculated and is transmitted as shown below.

CLAIMS AS AMENDED

	CLAIMS REMAINING AFTER AMENDMENT	HIGHEST # PREV. PAID FOR	NUMBER EXTRA CLAIMS PRESENT	RATE	ADDITIONAL FEE
TOTAL CLAIMS	12 -	20 =	0	x \$18.00	\$0.00
INDEP. CLAIMS	3 -	3 =	0	x \$86.00	\$0.00
Multiple Dependent Claims (check if applicable)	<input type="checkbox"/>				
TOTAL ADDITIONAL FEE FOR THIS AMENDMENT					\$0.00

- No additional fee is required for amendment.
- Please charge Deposit Account No. _____ in the amount of _____.
- A check in the amount of _____ to cover the filing fee is enclosed.
- The Director is hereby authorized to charge payment of the following fees associated with this communication or credit any overpayment to Deposit Account No.
 - Any additional filing fees required under 37 C.F.R. 1.16.
 - Any patent application processing fees under 37 CFR 1.17.



Dated: 27 May 2004

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I certify that this document and fee is being deposited on _____ with the U.S. Postal Service as first class mail under 37 C.F.R. 1.8 and is addressed to the Commissioner for Patents, P.O. Box 1450, Alexandria, VA 22313-1450.

Signature of Person Mailing Correspondence

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CC:



Serial No. 09/689,814

SEC.760

Amendment dated 5/27/2004

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re PATENT APPLICATION of:

Seung-pil Chung et al.

Group Art Unit: 1763

Serial No.: 09/689,814

Examiner: L. Alejandro Mulero

Filed: 13 October 2000

METHOD FOR REMOVING OXIDE
LAYER AND SEMICONDUCTOR
MANUFACTURING APPARATUS
FOR REMOVING OXIDE LAYER

AMENDMENT

U.S. Patent and Trademark Office
U.S. Patent and Trademark Office
2011 South Clark Place
Customer Window, Mail Stop **Non-Fee Amendment**
Crystal Plaza Two, Lobby, Room 1B03
Arlington, VA 22202

Sir:

In response to the Office Action dated 27 February 2004, the period for response to which is 27 May 2004, please amend the above-identified patent application as follows:

Amendments to the Claims are reflected in the listing of claims which begins on page 2 of this paper.

Remarks begin on page 7 of this paper.